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RF gun based MeV TEM

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UEM and its applications



Protein Structural Dynamics



Protein structural dynamics
Macromolecular structure
Reveal of functioning processes
New technologies and applications in medical biology.

Targets

Making Molecular Movie

- •Observation of single molecule motion.
 - •Ultrafast chemical reactions
 •Solvation dynamics
 - •Discovery of transition states and reaction intermediates.

Nano-technology/science

- •Transformation dynamics of novel nanoscale materials.
- •Creation of new functional materials and devices for nanotechnology.



Why use RF gun in microscopy?

The space-charge effect can be reduced. RF gun is operated with a high acceleration electric field up to 100 MV/m, which is x10 higher than that in DC electron gun.

✓A femtosecond relativistic-energy electron beam with high charge is available.

ex. 100-fs electron pulses with energy of 1~3MeV and charge of 1~10pC.

 Femtosecond single-shot imaging may be achieved.
 100-fs time-resolution & sub-nanometer spatial resolution in microscopy (goal for the scientists)



What RF electron gun?



Beam dynamics in RF gun

1) Longitudinal dynamics



Simulation of low-energy spread e⁻ beam



Energy spread as a function of laser pulse width

Beam dynamics in RF gun

2) Transverse dynamics

Emittance due to space-charge effect:

$$\mathcal{E}_{x,z}^{sc} = \frac{\pi}{4} \frac{1}{\alpha k} \frac{1}{\sin \phi_0} \frac{I_p}{I_A} \mu_{x,z} \qquad \mu_x = \sqrt{\langle \Gamma_x^2 \rangle \langle x^2 \rangle - \langle \Gamma_x x \rangle^2} = \frac{1}{3\sigma_x / \sigma_z + 5} \qquad \text{for a Gaussian distribution beam}$$

$$\mathcal{E}_x^{sc}[mm - mrad] = \frac{3.76 \times Q[pC]}{E_0[MV / m](2\sigma_x[mm] + \sigma_z[ps])}$$

$$E_0^{\sim} 100 \text{MV/m in RF gun}$$

$$\frac{\text{Emittance due to RF effect:}}{e_x^{rf}} = \sqrt{\langle p_x^2 \rangle \langle x^2 \rangle - \langle p_x x \rangle^2} = \alpha k \langle x^2 \rangle \sqrt{\langle \sin^2 \phi_f \rangle - \langle \sin \phi_f \rangle^2} \qquad \mathcal{E}_x^{sc} \sim 0.1 \text{ mm-mrad}$$

$$\mathcal{E}_x^{rf} = 2.73 \times 10^{-11} E_0 f^2 \sigma_x^2 \sigma_z^2$$

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Generation of low-emittance e⁻ beam with RF gun



RF gun based UED facilities

- Recently, the RF gun has been successfully used/proposed in UED facilities at BNL, SLAC, UCLA, Tsinghua Univ., Osaka Univ., DESY, Shanghai Jiaotong Univ., KAERI, ...
- The UED experiments indicate that the RF gun based MeV UED is a useful tool for the study of ultrafast dynamics with time resolution of 100 fs or less.

However,

Can RF gun be used in electron microscopy?What kind efforts and challenges are needed?



To understand,

we developed a prototype of time-resolved TEM using RF gun.

RF gun based electron microscopy (under development at Osaka Univ.)

Concept of RF gun based TEM



First prototype of RF gun based electron microscopy



Prototype of MeV UEM at Osaka Univ.

(height: 3m, diameter: 0.7m)

The prototype was constructed at the end of Oct. 2012.

Femtosecond RF gun at Osaka Univ.

Developed under the collaboration with KEK



Improvements:

remove two laser injection ports
a new turner system
new structure cavities
a new insertion function of photocathode (The photocathode is removable)



generate low-emittance and low-energyspread electron beam.

Design of 2T objective lens



Detection of MeV electron images

femtosecond Csl (TI) scintillator MeV electron beam Problems in MeV e⁻ image detection (Hamamatsu) •IIIu. Vol.(<50µm) Very low current, • Bright i.e. $\sim pA (10^7 \sim 10^8 \text{ e-'s/pulse})$ • High resol. (Column Structure) •Strong X-ray emission, Tough i.e. Background, pixel defect (for High Eng. Xray) • Large: 5x5cm² Damage by MeV electrons, i.e. scintillator, fiber Image to be shifted. **Thin Polymer** ORCA-R² CCD mirror (5µm) X, e Ŵ

The detection system was successfully used in UED measurement. (single-shot measurement with 10⁵ e⁻s/pulse)

Demonstrations of MeV ED/TEM imaging



Magnifications & resolutions





e⁻ energy: ~ MeV e⁻ number: ~10⁷/pulse





Using Obj. lens only



RF gun based UED at Osaka University

Electron energy: 1~3 MeV Time resolution: 100 fs

RF gun based MeV UED at Osaka Univ.

use of electron optical lenses as like in electron microscopy



Picture of UED system at Osaka Univ.



use of electron optical lenses, therefore, compact.

Detection of MeV electron diffraction

Requirements of MeV electron detector: high resolution, high efficiency, no damage



Problems

- Very low current, i.e. ~pA
- Small scattering angle, i.e. 0.1mrad
- Strong X-ray emissions,
 - i.e. Backgnd, pixel defect
- Damage by MeV electron,
 - i.e. scintillator, fiber
- Diff. Pattern to be magnified/shifted



Solution

- Csl: Small Illumination volume size-matched to CCD pixel
- Indirect exposure <u>Thin mirror +</u> Lens coupling
- No pixel defect observed yet
- Large detection area, i.e. 5x5cm²

Quality of MeV electron diffraction

Electron beam: 3 MeV, $8.9 \times 10^7 e/cm^2/pulse$ Sample: 180nm-thick single crystal Si



Y. Murooka, et al., Appl. Phys. Lett. 98, 251903 (2011)

Power of the technique: static diffractions

• Single-shot measurement



UED: Phase transformation on single-crystal Au



Conclusion and remarks

✓ Both RF gun based UED and UEM systems have been constructed at Osaka University.

✓In UED, single-shot and time-resolved measurements have been succeeded. The time resolution was achieved to be 100 fs.

✓In UEM, the demonstrations of MeV electron diffraction and imaging were carried out.

✓ Both experiments suggest that RF gun is very useful for ultrafast MeV electron diffraction and is also expected to be used in ultrafast electron microscopy.

However, great efforts and many challenges are required:

 \succ reduce further the emittance (<0.1 μ m) and energy spread (10⁻⁵ or less),

- ➤increase the beam brightness,
- > improve the stabilities on the charge and energy,
- >develop a detection of very electron with MeV energy, and so on.